M-Bond 450

EMEME Micro-Measurements



Strain Gage Adhesive



OTHER ACCESSORIES USED IN AN M-BOND 450 INSTALLATION:

- CSM Degreaser or GC-6 Isopropyl Alcohol
- Silicon-Carbide Paper
- M-Prep Conditioner A
- M-Prep Neutralizer 5A
- GSP-1 Gauze Sponges
- CSP-1 Cotton Applicators
- MJG-2 Mylar® Tape
- TFE-1 Teflon® Film
- HSC Spring Clamp
- GT-14 Pressure Pads and Backup Plates

DESCRIPTION

High-performance, two-component, solvent-thinned epoxy system specially formulated for high accuracy, elevated-temperature transducer applications.

CHARACTERISTICS

Operating Temperature Range:

Short Term: -452° to +750°F [-269° to +400°C]. *Long Term:* -452° to +500°F [-269° to +260°C].

Elongation Capabilities:

>5% at +75°F [+24°C].

Shelf Life: Minimum 6 months at +75°F [+24°C].

Pot Life: 6 weeks at +75°F [+24°C].

Clamping Pressure: 60 to 100psi [415 to 690kN/m²].

Cure Requirements:

Step 1: Air dry at +75°F [+24°C] 10 to 30 minutes. B-Stage: +225°F [+105°C] for 30 minutes. Cure: +350°F [+175°C] for 1 hour. Recommended Postcure: 1 hour at 50°F [30°C] above maximum operating temperature in 50°F [30°C] increments from +350°F [+175°C], dwelling 1 hour at each step.

PACKAGING

Kit:

4 bottles [12.5g ea] Curing Agent 4 bottles [12.5g ea] Resin

4 brush caps for applying adhesive

4 disposable mixing funnels

References: Instruction Bulletin B-152, "Instructions for the Application of Micro-Measurements M-Bond 450 Adhesive", included in each kit.

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